## INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99)

Application Number		10826762		
Filing Date		2004-04-16		
First Named Inventor John		Harper		
Art Unit		2628		
Examiner Name	Joni I	łsu		
Attomor Docket Number		119,0033119		

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Examiner Name	Joni F	łsu	
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